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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

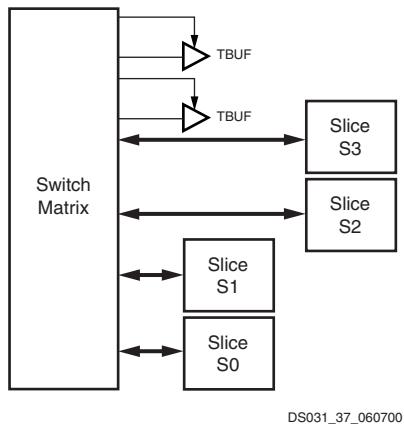
Product Status	Obsolete
Number of LABs/CLBs	8448
Number of Logic Elements/Cells	-
Total RAM Bits	2654208
Number of I/O	1104
Number of Gates	6000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FCBGA (40x40)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc2v6000-4ffg1517i">https://www.e-xfl.com/product-detail/xilinx/xc2v6000-4ffg1517i</a>

### 3-State Buffers

#### Introduction

Each Virtex-II CLB contains two 3-state drivers (TBUFs) that can drive on-chip busses. Each 3-state buffer has its own 3-state control pin and its own input pin.

Each of the four slices have access to the two 3-state buffers through the switch matrix, as shown in [Figure 27](#). TBUFs in neighboring CLBs can access slice outputs by direct connects. The outputs of the 3-state buffers drive horizontal routing resources used to implement 3-state busses.



**Figure 27: Virtex-II 3-State Buffers**

The 3-state buffer logic is implemented using AND-OR logic rather than 3-state drivers, so that timing is more predictable and less load dependant especially with larger devices.

#### Locations / Organization

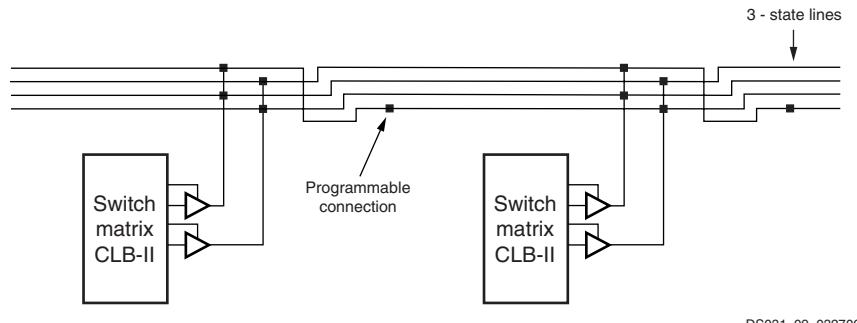
Four horizontal routing resources per CLB are provided for on-chip 3-state busses. Each 3-state buffer has access alternately to two horizontal lines, which can be partitioned as shown in [Figure 28](#). The switch matrices corresponding to SelectRAM memory and multiplier or I/O blocks are skipped.

#### Number of 3-State Buffers

[Table 11](#) shows the number of 3-state buffers available in each Virtex-II device. The number of 3-state buffers is twice the number of CLB elements.

**Table 11: Virtex-II 3-State Buffers**

Device	3-State Buffers per Row	Total Number of 3-State Buffers
XC2V40	16	128
XC2V80	16	256
XC2V250	32	768
XC2V500	48	1,536
XC2V1000	64	2,560
XC2V1500	80	3,840
XC2V2000	96	5,376
XC2V3000	112	7,168
XC2V4000	144	11,520
XC2V6000	176	16,896
XC2V8000	208	23,296



**Figure 28: 3-State Buffer Connection to Horizontal Lines**

#### CLB/Slice Configurations

[Table 12](#) summarizes the logic resources in one CLB. All of the CLBs are identical and each CLB or slice can be implemented in one of the configurations listed. [Table 13](#) shows the available resources in all CLBs.

**Table 12: Logic Resources in One CLB**

Slices	LUTs	Flip-Flops	MULT_ANDs	Arithmetic & Carry-Chains	SOP Chains	Distributed SelectRAM	Shift Registers	TBUF
4	8	8	8	2	2	128 bits	128 bits	2

## IOB Input Switching Characteristics Standard Adjustments

Table 15 gives all standard-specific data input delay adjustments.

Table 15: IOB Input Switching Characteristics Standard Adjustments

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL	$T_{ILVTTL}$	0.00	0.00	0.00	ns
LVCMOS (Low-Voltage CMOS), 3.3V	LVCMOS33	$T_{ILVCMOS33}$	0.00	0.00	0.00	ns
LVCMOS, 2.5V	LVCMOS25	$T_{ILVCMOS25}$	0.11	0.11	0.12	ns
LVCMOS, 1.8V	LVCMOS18	$T_{ILVCMOS18}$	0.42	0.43	0.49	ns
LVCMOS, 1.5V	LVCMOS15	$T_{ILVCMOS15}$	0.98	1.00	1.15	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	$T_{ILVDS\_25}$	0.60	0.60	0.69	ns
LVDS, 3.3V	LVDS_33	$T_{ILVDS\_33}$	0.60	0.60	0.69	ns
LVDSEXT (Extended Mode), 2.5V	LVDSEXT_25	$T_{ILVDSEXT\_25}$	0.68	0.69	0.79	ns
LVDSEXT, 3.3V	LVDSEXT_33	$T_{ILVDSEXT\_33}$	0.56	0.56	0.65	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	$T_{ILVDS\_25}$	0.48	0.49	0.56	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	$T_{IBLVDS\_25}$	0.68	0.69	0.79	ns
LDT (HyperTransport), 2.5V	LDT_25	$T_{ILD\_25}$	0.48	0.49	0.56	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$T_{ILVPECL\_33}$	0.60	0.60	0.69	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	$T_{IPCI33\_3}$	0.00	0.00	0.00	ns
PCI, 66 MHz, 3.3V	PCI66_3	$T_{IPCI66\_3}$	0.00	0.00	0.00	ns
PCI-X, 133 MHz, 3.3V	PCIX	$T_{IPCIX}$	0.00	0.00	0.00	ns
GTL (Gunning Transceiver Logic)	GTL	$T_{IGTL}$	0.42	0.42	0.48	ns
GTL Plus	GTLP	$T_{IGTLP}$	0.42	0.42	0.48	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	$T_{IHSTL\_I}$	0.42	0.42	0.48	ns
HSTL, Class II	HSTL_II	$T_{IHSTL\_II}$	0.42	0.42	0.48	ns
HSTL, Class III	HSTL_III	$T_{IHSTL\_III}$	0.42	0.42	0.48	ns
HSTL, Class IV	HSTL_IV	$T_{IHSTL\_IV}$	0.42	0.42	0.48	ns
HSTL, Class I, 1.8V	HSTL_I_18	$T_{IHSTL\_I\_18}$	0.42	0.42	0.48	ns
HSTL, Class II, 1.8V	HSTL_II_18	$T_{IHSTL\_II\_18}$	0.42	0.42	0.48	ns
HSTL, Class III, 1.8V	HSTL_III_18	$T_{IHSTL\_III\_18}$	0.42	0.42	0.48	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	$T_{IHSTL\_IV\_18}$	0.42	0.42	0.48	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	$T_{ISSTL18\_I}$	0.42	0.42	0.48	ns
SSTL, Class II, 1.8V	SSTL18_II	$T_{ISSTL18\_II}$	0.42	0.42	0.48	ns
SSTL, Class I, 2.5V	SSTL2_I	$T_{ISSTL2\_I}$	0.42	0.42	0.48	ns
SSTL, Class II, 2.5V	SSTL2_II	$T_{ISSTL2\_II}$	0.42	0.42	0.48	ns
SSTL, Class I, 3.3V	SSTL3_I	$T_{ISSTL3\_I}$	0.35	0.35	0.40	ns
SSTL, Class II, 3.3V	SSTL3_II	$T_{ISSTL3\_II}$	0.35	0.35	0.40	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	$T_{IAGP}$	0.35	0.35	0.40	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	$T_{ILVDCI\_33}$	0.00	0.00	0.00	ns
LVDCI, 2.5V	LVDCI_25	$T_{ILVDCI\_25}$	0.11	0.11	0.12	ns
LVDCI, 1.8V	LVDCI_18	$T_{ILVDCI\_18}$	0.42	0.43	0.49	ns
LVDCI, 1.5V	LVDCI_15	$T_{ILVDCI\_15}$	0.98	1.00	1.14	ns

## Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

Table 4: Virtex-II Pin Definitions

Pin Name	Direction	Description
<b>User I/O Pins</b>		
IO_LXXY_#	Input/Output/Bidirectional	All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled “ <b>IO_LXXY_#</b> ”, where: <b>IO</b> indicates a user I/O pin. <b>LXXY</b> indicates a differential pair, with <b>XX</b> a unique pair in the bank and <b>Y = P/N</b> for the positive and negative sides of the differential pair. # indicates the bank number (0 through 7)
<b>Dual-Function Pins</b>		
IO_LXXY_#/ZZZ		The dual-function pins are labelled “ <b>IO_LXXY_#/ZZZ</b> ”, where <b>ZZZ</b> can be one of the following pins: Per Bank - <b>VRP</b> , <b>VRN</b> , or <b>VREF</b> Globally - <b>GCLKx(S/P)</b> , <b>BUSY/DOUT</b> , <b>INIT_B</b> , <b>D0/DIN – D7</b> , <b>RDWR_B</b> , or <b>CS_B</b>
<b>With /ZZZ:</b>		
D0/DIN, D1, D2, D3, D4, D5, D6, D7	Input/Output	<ul style="list-style-type: none"> <li><i>In SelectMAP mode</i>, D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained.</li> <li><i>In bit-serial modes</i>, DIN (D0) is the single-data input. This pin becomes a user I/O after configuration.</li> </ul>
CS_B	Input	In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
RDWR_B	Input	In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
BUSY/DOUT	Output	<ul style="list-style-type: none"> <li><i>In SelectMAP mode</i>, BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.</li> <li><i>In bit-serial modes</i>, DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration.</li> </ul>
INIT_B	Bidirectional (open-drain)	When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration.
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
ALT_VRP	Input	This is the alternative pin for the DCI voltage reference resistor of P transistor.
ALT_VRN	Input	This is the alternative pin for the DCI voltage reference resistor of N transistor.
V <sub>REF</sub>	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
<b>Dedicated Pins<sup>(1)</sup></b>		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
<hr/>				
3	IO_L96N_3	J16		
3	IO_L96P_3	J15		
3	IO_L94N_3	J14		
3	IO_L94P_3	J13		
3	IO_L93N_3/VREF_3	K16	NC	
3	IO_L93P_3	K15	NC	
3	IO_L91N_3	K14	NC	
3	IO_L91P_3	K13	NC	
3	IO_L45N_3/VREF_3	K12	NC	NC
3	IO_L45P_3	L12	NC	NC
3	IO_L43N_3	L16	NC	NC
3	IO_L43P_3	L15	NC	NC
3	IO_L06N_3	L14	NC	
3	IO_L06P_3	L13	NC	
3	IO_L04N_3	M16	NC	
3	IO_L04P_3	M15	NC	
3	IO_L03N_3/VREF_3	M14		
3	IO_L03P_3	M13		
3	IO_L02N_3/VRP_3	N15		
3	IO_L02P_3/VRN_3	N14		
3	IO_L01N_3	N16		
3	IO_L01P_3	P16		
<hr/>				
4	IO_L01N_4/BUSY/DOUT <sup>(1)</sup>	T14		
4	IO_L01P_4/INIT_B	T13		
4	IO_L02N_4/D0/DIN <sup>(1)</sup>	P13		
4	IO_L02P_4/D1	R13		
4	IO_L03N_4/D2/ALT_VRP_4	N12		
4	IO_L03P_4/D3/ALT_VRN_4	P12		
4	IO_L04N_4/VREF_4	R12	NC	NC
4	IO_L04P_4	T12	NC	NC
4	IO_L05N_4/VRP_4	N11	NC	NC
4	IO_L05P_4/VRN_4	P11	NC	NC

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L02N_4/D0/DIN <sup>(1)</sup>	V18		
4	IO_L02P_4/D1	V17		
4	IO_L03N_4/D2/ALT_VRP_4	W18		
4	IO_L03P_4/D3/ALT_VRN_4	Y18		
4	IO_L04N_4/VREF_4	AA18		
4	IO_L04P_4	AB18		
4	IO_L05N_4/VRP_4	W17		
4	IO_L05P_4/VRN_4	Y17		
4	IO_L06N_4	AA17		
4	IO_L06P_4	AB17		
4	IO_L19N_4	V16	NC	NC
4	IO_L19P_4	V15	NC	NC
4	IO_L21N_4	W16	NC	NC
4	IO_L21P_4/VREF_4	Y16	NC	NC
4	IO_L22N_4	AA16	NC	NC
4	IO_L22P_4	AB16	NC	NC
4	IO_L24N_4	W15	NC	NC
4	IO_L24P_4	Y15	NC	NC
4	IO_L49N_4	AA15	NC	
4	IO_L49P_4	AB15	NC	
4	IO_L51N_4	U14	NC	
4	IO_L51P_4/VREF_4	V14	NC	
4	IO_L52N_4	W14	NC	
4	IO_L52P_4	Y14	NC	
4	IO_L54N_4	AA14	NC	
4	IO_L54P_4	AB14	NC	
4	IO_L91N_4/VREF_4	U13		
4	IO_L91P_4	V13		
4	IO_L92N_4	W13		
4	IO_L92P_4	Y13		
4	IO_L93N_4	AA13		
4	IO_L93P_4	AB13		
4	IO_L94N_4/VREF_4	U12		
4	IO_L94P_4	V12		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L78N_7	M2	NC	
7	IO_L76P_7	M5	NC	
7	IO_L76N_7	M6	NC	
7	IO_L75P_7/VREF_7	M3	NC	
7	IO_L75N_7	M4	NC	
7	IO_L73P_7	M7	NC	
7	IO_L73N_7	M8	NC	
7	IO_L72P_7	L1		
7	IO_L72N_7	L2		
7	IO_L70P_7	L5		
7	IO_L70N_7	L6		
7	IO_L69P_7/VREF_7	L3		
7	IO_L69N_7	L4		
7	IO_L67P_7	K1		
7	IO_L67N_7	J1		
7	IO_L54P_7	K3		
7	IO_L54N_7	K4		
7	IO_L52P_7	K5		
7	IO_L52N_7	K6		
7	IO_L51P_7/VREF_7	L8		
7	IO_L51N_7	L7		
7	IO_L49P_7	J2		
7	IO_L49N_7	H1		
7	IO_L48P_7	J3		
7	IO_L48N_7	J4		
7	IO_L46P_7	J5		
7	IO_L46N_7	J6		
7	IO_L45P_7/VREF_7	H5		
7	IO_L45N_7	H4		
7	IO_L43P_7	K7		
7	IO_L43N_7	J7		
7	IO_L25P_7	H2	NC	NC
7	IO_L25N_7	H3	NC	NC
7	IO_L24P_7	G1		
7	IO_L24N_7	F1		
7	IO_L22P_7	G3		
7	IO_L22N_7	G4		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	VCCINT	H19		
NA	VCCINT	H8		
NA	GND	AF26		
NA	GND	AF1		
NA	GND	AE25		
NA	GND	AE14		
NA	GND	AE13		
NA	GND	AE2		
NA	GND	AD24		
NA	GND	AD3		
NA	GND	AC23		
NA	GND	AC4		
NA	GND	AB22		
NA	GND	AB5		
NA	GND	AA21		
NA	GND	AA6		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U11		
NA	GND	U10		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		
NA	GND	T13		
NA	GND	T12		
NA	GND	T11		
NA	GND	T10		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
2	IO_L01P_2	D23		
2	IO_L02N_2/VRP_2	E21		
2	IO_L02P_2/VRN_2	E22		
2	IO_L03N_2	F21		
2	IO_L03P_2/VREF_2	F20		
2	IO_L04N_2	G20		
2	IO_L04P_2	G19		
2	IO_L06N_2	H18		
2	IO_L06P_2	J17		
2	IO_L19N_2	D24		
2	IO_L19P_2	E23		
2	IO_L21N_2	E24		
2	IO_L21P_2/VREF_2	F24		
2	IO_L22N_2	F23		
2	IO_L22P_2	G23		
2	IO_L24N_2	G21		
2	IO_L24P_2	G22		
2	IO_L43N_2	H19		
2	IO_L43P_2	H20		
2	IO_L45N_2	J18		
2	IO_L45P_2/VREF_2	J19		
2	IO_L46N_2	K17		
2	IO_L46P_2	K18		
2	IO_L48N_2	H23		
2	IO_L48P_2	H24		
2	IO_L49N_2	H21		
2	IO_L49P_2	H22		
2	IO_L51N_2	J24		
2	IO_L51P_2/VREF_2	K24		
2	IO_L52N_2	J22		
2	IO_L52P_2	J23		
2	IO_L54N_2	J20		
2	IO_L54P_2	J21		
2	IO_L67N_2	K19	NC	
2	IO_L67P_2	K20	NC	
2	IO_L69N_2	L17	NC	

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
5	IO_L78P_5	AF16	NC	NC
5	IO_L77N_5	AB16	NC	NC
5	IO_L77P_5	AB17	NC	NC
5	IO_L76N_5	AJ19	NC	NC
5	IO_L76P_5	AJ18	NC	NC
5	IO_L75N_5/VREF_5	AG18	NC	NC
5	IO_L75P_5	AF18	NC	NC
5	IO_L74N_5	AE17	NC	NC
5	IO_L74P_5	AE18	NC	NC
5	IO_L73N_5	AK20	NC	NC
5	IO_L73P_5	AK19	NC	NC
5	IO_L72N_5	AH20	NC	
5	IO_L72P_5	AH19	NC	
5	IO_L71N_5	AD18	NC	
5	IO_L71P_5	AD19	NC	
5	IO_L70N_5	AJ21	NC	
5	IO_L70P_5	AJ20	NC	
5	IO_L69N_5/VREF_5	AG19	NC	
5	IO_L69P_5	AG20	NC	
5	IO_L68N_5	AC18	NC	
5	IO_L68P_5	AC19	NC	
5	IO_L67N_5	AK22	NC	
5	IO_L67P_5	AK21	NC	
5	IO_L54N_5	AF21		
5	IO_L54P_5	AF20		
5	IO_L53N_5	AH22		
5	IO_L53P_5	AH23		
5	IO_L52N_5	AG22		
5	IO_L52P_5	AG21		
5	IO_L51N_5/VREF_5	AF22		
5	IO_L51P_5	AF23		
5	IO_L50N_5	AE19		
5	IO_L50P_5	AE20		
5	IO_L49N_5	AJ23		
5	IO_L49P_5	AJ22		
5	IO_L24N_5	AF24		
5	IO_L24P_5	AG23		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
2	VCCO_2	L10		
2	VCCO_2	L9		
2	VCCO_2	K9		
2	VCCO_2	E2		
3	VCCO_3	AF2		
3	VCCO_3	AA9		
3	VCCO_3	Y10		
3	VCCO_3	Y9		
3	VCCO_3	W10		
3	VCCO_3	W9		
3	VCCO_3	V10		
3	VCCO_3	V9		
3	VCCO_3	V3		
3	VCCO_3	U10		
3	VCCO_3	T10		
4	VCCO_4	AJ5		
4	VCCO_4	AH13		
4	VCCO_4	AB13		
4	VCCO_4	AB12		
4	VCCO_4	AB11		
4	VCCO_4	AB10		
4	VCCO_4	AA15		
4	VCCO_4	AA14		
4	VCCO_4	AA13		
4	VCCO_4	AA12		
4	VCCO_4	AA11		
5	VCCO_5	AJ26		
5	VCCO_5	AH18		
5	VCCO_5	AB21		
5	VCCO_5	AB20		
5	VCCO_5	AB19		
5	VCCO_5	AB18		
5	VCCO_5	AA20		
5	VCCO_5	AA19		
5	VCCO_5	AA18		
5	VCCO_5	AA17		
5	VCCO_5	AA16		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	VCCINT	N20		
NA	VCCINT	N11		
NA	VCCINT	M20		
NA	VCCINT	M11		
NA	VCCINT	L20		
NA	VCCINT	L19		
NA	VCCINT	L18		
NA	VCCINT	L17		
NA	VCCINT	L16		
NA	VCCINT	L15		
NA	VCCINT	L14		
NA	VCCINT	L13		
NA	VCCINT	L12		
NA	VCCINT	L11		
NA	VCCINT	K21		
NA	VCCINT	K10		
NA	VCCINT	J22		
NA	VCCINT	J9		
NA	GND	AK23		
NA	GND	AK8		
NA	GND	AJ29		
NA	GND	AJ2		
NA	GND	AH28		
NA	GND	AH21		
NA	GND	AH10		
NA	GND	AH3		
NA	GND	AG27		
NA	GND	AG4		
NA	GND	AF26		
NA	GND	AF19		
NA	GND	AF12		
NA	GND	AF5		
NA	GND	AE25		
NA	GND	AE6		
NA	GND	AD17		
NA	GND	AD14		
NA	GND	AC30		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
1	IO_L69P_1	F13	
1	IO_L68N_1	C11	
1	IO_L68P_1	C12	
1	IO_L67N_1	B11	
1	IO_L67P_1	B12	
1	IO_L60N_1	F11	NC
1	IO_L60P_1	F12	NC
1	IO_L54N_1	D10	
1	IO_L54P_1	D11	
1	IO_L53N_1	G12	
1	IO_L53P_1	G13	
1	IO_L52N_1	B9	
1	IO_L52P_1	B10	
1	IO_L51N_1/VREF_1	B8	
1	IO_L51P_1	A9	
1	IO_L50N_1	K14	
1	IO_L50P_1	K13	
1	IO_L49N_1	A6	
1	IO_L49P_1	A7	
1	IO_L30N_1	D9	
1	IO_L30P_1	C9	
1	IO_L29N_1	H13	
1	IO_L29P_1	H12	
1	IO_L28N_1	C7	
1	IO_L28P_1	C8	
1	IO_L27N_1/VREF_1	E11	
1	IO_L27P_1	E10	
1	IO_L26N_1	J13	
1	IO_L26P_1	K12	
1	IO_L25N_1	B6	
1	IO_L25P_1	B7	
1	IO_L24N_1	E8	
1	IO_L24P_1	E9	
1	IO_L23N_1	G10	
1	IO_L23P_1	G11	
1	IO_L22N_1	A4	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	V19	
NA	GND	V18	
NA	GND	V17	
NA	GND	V16	
NA	GND	V15	
NA	GND	V14	
NA	GND	U21	
NA	GND	U20	
NA	GND	U19	
NA	GND	U18	
NA	GND	U17	
NA	GND	U16	
NA	GND	U15	
NA	GND	U14	
NA	GND	T26	
NA	GND	T21	
NA	GND	T20	
NA	GND	T19	
NA	GND	T18	
NA	GND	T17	
NA	GND	T16	
NA	GND	T15	
NA	GND	T14	
NA	GND	T9	
NA	GND	R33	
NA	GND	R21	
NA	GND	R20	
NA	GND	R19	
NA	GND	R18	
NA	GND	R17	
NA	GND	R16	
NA	GND	R15	
NA	GND	R14	
NA	GND	R2	
NA	GND	P28	
NA	GND	P21	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L22P_0	A34		
0	IO_L23N_0	K27		
0	IO_L23P_0	K26		
0	IO_L24N_0	F29		
0	IO_L24P_0	F30		
0	IO_L25N_0	B32		
0	IO_L25P_0	B33		
0	IO_L26N_0	L26		
0	IO_L26P_0	L25		
0	IO_L27N_0	G28		
0	IO_L27P_0/VREF_0	G29		
0	IO_L28N_0	C30		
0	IO_L28P_0	C31		
0	IO_L29N_0	J27		
0	IO_L29P_0	J26		
0	IO_L30N_0	D30		
0	IO_L30P_0	D31		
0	IO_L31N_0	A31	NC	
0	IO_L31P_0	A32	NC	
0	IO_L32N_0	H27	NC	
0	IO_L32P_0	H26	NC	
0	IO_L33N_0	F27	NC	
0	IO_L33P_0/VREF_0	F28	NC	
0	IO_L34N_0	B30	NC	
0	IO_L34P_0	B31	NC	
0	IO_L35N_0	M24	NC	
0	IO_L35P_0	M23	NC	
0	IO_L36N_0	D28	NC	
0	IO_L36P_0	D29	NC	
0	IO_L49N_0	C28		
0	IO_L49P_0	C29		
0	IO_L50N_0	K25		
0	IO_L50P_0	L24		
0	IO_L51N_0	E27		
0	IO_L51P_0/VREF_0	E28		
0	IO_L52N_0	A29		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L09P_2/VREF_2	H7	NC	
2	IO_L10N_2	G3	NC	
2	IO_L10P_2	F3	NC	
2	IO_L11N_2	J8	NC	
2	IO_L11P_2	K8	NC	
2	IO_L12N_2	H5	NC	
2	IO_L12P_2	G5	NC	
2	IO_L19N_2	G1		
2	IO_L19P_2	F1		
2	IO_L20N_2	K9		
2	IO_L20P_2	L10		
2	IO_L21N_2	K7		
2	IO_L21P_2/VREF_2	J7		
2	IO_L22N_2	H2		
2	IO_L22P_2	G2		
2	IO_L23N_2	L9		
2	IO_L23P_2	M9		
2	IO_L24N_2	H4		
2	IO_L24P_2	G4		
2	IO_L25N_2	J3		
2	IO_L25P_2	H3		
2	IO_L26N_2	M10		
2	IO_L26P_2	N10		
2	IO_L27N_2	K6		
2	IO_L27P_2/VREF_2	J6		
2	IO_L28N_2	K5		
2	IO_L28P_2	J5		
2	IO_L29N_2	N11		
2	IO_L29P_2	P11		
2	IO_L30N_2	M7		
2	IO_L30P_2	L7		
2	IO_L31N_2	J1	NC	
2	IO_L31P_2	H1	NC	
2	IO_L32N_2	L8	NC	
2	IO_L32P_2	M8	NC	
2	IO_L33N_2	K4	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L91P_4	AV18		
4	IO_L92N_4	AH20		
4	IO_L92P_4	AJ20		
4	IO_L93N_4	AR19		
4	IO_L93P_4	AT18		
4	IO_L94N_4/VREF_4	AW19		
4	IO_L94P_4	AW18		
4	IO_L95N_4/GCLK3S	AL20		
4	IO_L95P_4/GCLK2P	AM20		
4	IO_L96N_4/GCLK1S	AU19		
4	IO_L96P_4/GCLK0P	AT19		
5	IO_L96N_5/GCLK7S	AP21		
5	IO_L96P_5/GCLK6P	AP20		
5	IO_L95N_5/GCLK5S	AN21		
5	IO_L95P_5/GCLK4P	AN22		
5	IO_L94N_5	AU21		
5	IO_L94P_5/VREF_5	AU20		
5	IO_L93N_5	AR21		
5	IO_L93P_5	AR20		
5	IO_L92N_5	AM21		
5	IO_L92P_5	AM22		
5	IO_L91N_5	AW22		
5	IO_L91P_5/VREF_5	AW21		
5	IO_L85N_5	AV22	NC	NC
5	IO_L85P_5	AV21	NC	NC
5	IO_L84N_5	AT22		
5	IO_L84P_5	AT21		
5	IO_L83N_5	AL21		
5	IO_L83P_5	AL22		
5	IO_L82N_5	AW24		
5	IO_L82P_5	AW23		
5	IO_L81N_5/VREF_5	AR23		
5	IO_L81P_5	AR22		
5	IO_L80N_5	AK21		
5	IO_L80P_5	AK22		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L55N_5	AV28		
5	IO_L55P_5	AV27		
5	IO_L54N_5	AP27		
5	IO_L54P_5	AP26		
5	IO_L53N_5	AN25		
5	IO_L53P_5	AN26		
5	IO_L52N_5	AU29		
5	IO_L52P_5	AU28		
5	IO_L51N_5/VREF_5	AR28		
5	IO_L51P_5	AR27		
5	IO_L50N_5	AJ24		
5	IO_L50P_5	AJ25		
5	IO_L49N_5	AW30		
5	IO_L49P_5	AW29		
5	IO_L36N_5	AT29	NC	
5	IO_L36P_5	AT28	NC	
5	IO_L35N_5	AK25	NC	
5	IO_L35P_5	AL26	NC	
5	IO_L34N_5	AV31	NC	
5	IO_L34P_5	AV30	NC	
5	IO_L33N_5/VREF_5	AP29	NC	
5	IO_L33P_5	AP28	NC	
5	IO_L32N_5	AK26	NC	
5	IO_L32P_5	AJ26	NC	
5	IO_L31N_5	AW32	NC	
5	IO_L31P_5	AW31	NC	
5	IO_L30N_5	AM27		
5	IO_L30P_5	AM26		
5	IO_L29N_5	AN28		
5	IO_L29P_5	AN29		
5	IO_L28N_5	AU31		
5	IO_L28P_5	AU30		
5	IO_L27N_5/VREF_5	AT31		
5	IO_L27P_5	AT30		
5	IO_L26N_5	AH25		
5	IO_L26P_5	AH26		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	VCCO_3	AA13		
4	VCCO_4	AV14		
4	VCCO_4	AU18		
4	VCCO_4	AR11		
4	VCCO_4	AN13		
4	VCCO_4	AL15		
4	VCCO_4	AJ17		
4	VCCO_4	AG19		
4	VCCO_4	AG18		
4	VCCO_4	AG17		
4	VCCO_4	AG16		
4	VCCO_4	AG15		
4	VCCO_4	AG14		
4	VCCO_4	AF19		
4	VCCO_4	AF18		
4	VCCO_4	AF17		
4	VCCO_4	AF16		
4	VCCO_4	AF15		
5	VCCO_5	AV26		
5	VCCO_5	AU22		
5	VCCO_5	AR29		
5	VCCO_5	AN27		
5	VCCO_5	AL25		
5	VCCO_5	AJ23		
5	VCCO_5	AG26		
5	VCCO_5	AG25		
5	VCCO_5	AG24		
5	VCCO_5	AG23		
5	VCCO_5	AG22		
5	VCCO_5	AG21		
5	VCCO_5	AF25		
5	VCCO_5	AF24		
5	VCCO_5	AF23		
5	VCCO_5	AF22		
5	VCCO_5	AF21		
6	VCCO_6	AJ35		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
0	IO_L49N_0	C23	
0	IO_L49P_0	C22	
0	IO_L50N_0	E22	
0	IO_L50P_0	E21	
0	IO_L51N_0	F21	
0	IO_L51P_0/VREF_0	F20	
0	IO_L52N_0	A24	
0	IO_L52P_0	A23	
0	IO_L53N_0	E20	
0	IO_L53P_0	E19	
0	IO_L54N_0	B22	
0	IO_L54P_0	B21	
0	IO_L67N_0	D21	
0	IO_L67P_0	D20	
0	IO_L68N_0	J20	
0	IO_L68P_0	J19	
0	IO_L69N_0	F19	
0	IO_L69P_0/VREF_0	F18	
0	IO_L70N_0	A22	
0	IO_L70P_0	A21	
0	IO_L71N_0	H19	
0	IO_L71P_0	H17	
0	IO_L72N_0	C21	
0	IO_L72P_0	C20	
0	IO_L73N_0	B20	
0	IO_L73P_0	B19	
0	IO_L74N_0	G18	
0	IO_L74P_0	G17	
0	IO_L75N_0	E18	
0	IO_L75P_0/VREF_0	D17	
0	IO_L76N_0	A20	
0	IO_L76P_0	A19	
0	IO_L77N_0	D19	
0	IO_L77P_0	D18	
0	IO_L78N_0	C19	
0	IO_L78P_0	C17	
0	IO_L91N_0/VREF_0	K18	
0	IO_L91P_0	J18	

## Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
11/07/00	1.0	Early access draft.
11/22/00	1.1	<p>Initial Xilinx release. Made the following corrections:</p> <p>CS144 package - <a href="#">Table 5, page 5</a>:</p> <ul style="list-style-type: none"> <li>Added missing pin D10 in Bank 1.</li> <li>Changed dedicated pins A2 and B2 to RSVD (from DXN and DXP).</li> </ul> <p>FG256 package - <a href="#">Table 6, page 10</a>:</p> <ul style="list-style-type: none"> <li>Changed dedicated pins A3 and A4 to RSVD (from DXN and DXP).</li> </ul> <p>FG896 package - <a href="#">Table 11, page 94</a>:</p> <ul style="list-style-type: none"> <li>Corrected pin AG1 in Bank 4 to be AG12.</li> </ul> <p>FF1152 package - <a href="#">Table 12, page 120</a>:</p> <ul style="list-style-type: none"> <li>Corrected pin Y3 in Bank 6 to be Y32.</li> </ul>
12/19/00	1.2	Reverse designations were fixed for pins in every package.
01/25/01	1.3	Data sheet divided into four modules (per current style standard). DXN and DXP pin information added for CS144 package ( <a href="#">Table 5</a> ) and FG256 package ( <a href="#">Table 6</a> ).
02/07/01	1.4	DXN and DXP pin information was changed back to RSVD for the CS144 package ( <a href="#">Table 5</a> ) and the FG256 package ( <a href="#">Table 6</a> ).
04/02/01	1.5	<ul style="list-style-type: none"> <li>ALT_VRN and ALT_VRP pin information was added for each package.</li> <li><a href="#">Table 8, page 34</a> – added No Connect designations for the XC2V1500 device in the FG676 package.</li> <li>Reverted to traditional double-column format.</li> </ul>
11/07/01	1.6	<ul style="list-style-type: none"> <li>Updated list of devices supported in the FF1152, FF1517, and BF957 packages.</li> </ul>
09/26/02	1.7	<ul style="list-style-type: none"> <li>Updated <a href="#">Table 3</a> to reflect devices supported in the BG728 and BF957 packages.</li> <li>Added mention of LVPECL to pin definition in <a href="#">Table 4</a>.</li> </ul>
10/07/02	1.8	<ul style="list-style-type: none"> <li>Corrected <a href="#">Table 10</a> heading to reflect supported devices in the BG728 package.</li> </ul>
12/06/02	1.8.1	<ul style="list-style-type: none"> <li>Enhanced the description of the PWRDWN_B pin in <a href="#">Table 4</a>.</li> </ul>
05/07/03	1.8.2	<ul style="list-style-type: none"> <li>Added clarification to <a href="#">Table 4</a> and all device pinout tables regarding the dual-use nature of pins D0/DIN and BUSY/DOUT during configuration.</li> </ul>
06/19/03	1.8.3	<ul style="list-style-type: none"> <li>The final GND pin in each of five pinout tables was inadvertently deleted in v1.8.2. This revision restores the deleted GND pins as follows: <ul style="list-style-type: none"> <li>Pin C5, <a href="#">Table 5, page 5</a> (CS144)</li> <li>Pin A1, <a href="#">Table 6, page 10</a> (FG256)</li> <li>Pin A2, <a href="#">Table 10, page 72</a> (BG728)</li> <li>Pin A2, <a href="#">Table 12, page 120</a> (FF1152)</li> <li>Pin AL30, <a href="#">Table 14, page 198</a> (BF957)</li> </ul> </li> </ul>
08/01/03	2.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.
03/29/04	2.0.1	Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	Added references to, and new package drawings for, Pb-free wire-bond packages CSG, FGG, and BGG. (Revision number advanced to level of complete data sheet.)
03/01/05	3.4	<a href="#">Table 4</a> : Changed Direction for User I/O pins (IO_LXXY_#) from “Input/Output” to “Input/Output/Bidirectional”. Added requirement to V <sub>BATT</sub> to connect pin to V <sub>CCAUX</sub> or GND if battery is not used.
11/05/07	3.5	Updated copyright notice and legal disclaimer.